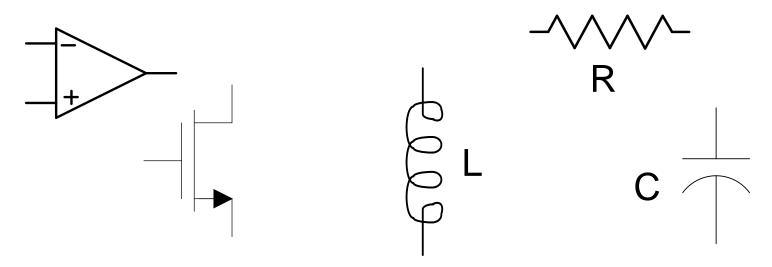
EE 508 Lecture 14

Statistical Characterization of Filter Characteristics

Effects of manufacturing variations on components



- A rigorous statistical analysis can be used to analytically predict how components vary and how component variations impact circuit performance
- Monte Carlo simulations are often used to simulate effects of component variations
 - Requires minimal statistical knowledge to use MC simulations
 - Simulation times may be prohibitively long to get useful results
 - Gives little insight into specific source of problems
 - Must be sure to correctly include correlations in setup
- Often key statistical information is not readily available from the foundry

Modeling process variations in semiconductor processes



$$X = X_{NOM} + x_{RPROC} + x_{RWAFER} + x_{RDIE} + x_{RLGRAD} + x_{RLVAR}$$

 $x_{\text{RPROC}}, x_{\text{RWAFER}}, x_{\text{RDIE}}, x_{\text{RLVAR}}$ often assumed to be Gausian with zero mean

Magnitude of x_{RLGRAD} is usually assumed Gaussian with zero mean, direction is uniform from 0° to 360°

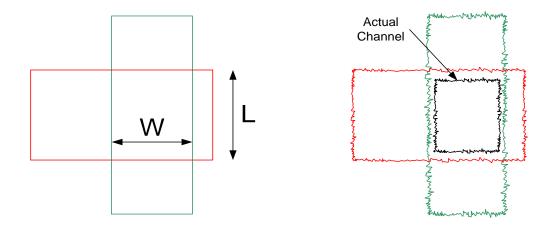
$$\sigma_{\scriptscriptstyle PROC} >> \sigma_{\scriptscriptstyle WAFER} >> \sigma_{\scriptscriptstyle DIE}$$
 $\sigma_{\scriptscriptstyle DIE} >> \sigma_{\scriptscriptstyle LVAR}$ $\sigma_{\scriptscriptstyle DIE} >> \sigma_{\scriptscriptstyle IGRAD|}$

 $\sigma_{\scriptscriptstyle LV\!AR}$ Strongly dependent upon area and layout

$$\sigma_{\scriptscriptstyle LVAR} \sim \frac{1}{\sqrt{\text{Area}}}$$
 $\sigma_{\scriptscriptstyle LVAR} \sim \text{Perimeter}$

Relative size between σ_{LVAR} and $\sigma_{|\text{GRAD}|}$ dependent upon A, P, and process

Effects of layout on local random variations



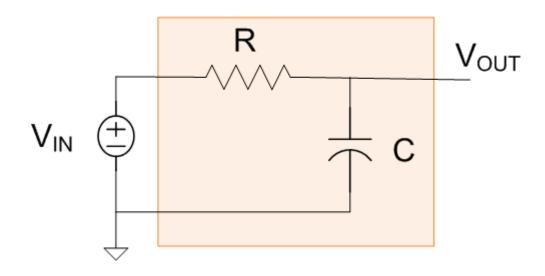
Drawn and Actual Features for MOS Transistor

Variations also occur vertically in both oxide thickness and doping levels/profiles and often these will dominate the lateral effects

Modeling process variations in semiconductor processes



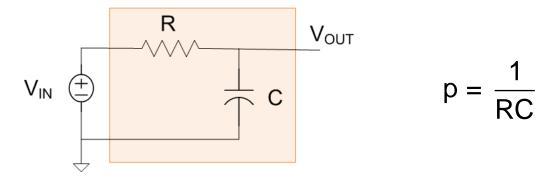
- Statistics associated with value of dimensioned parameters (poles, GB, SR,R,C,transresistance gains, transconductance gains, ... dominated by x_{RPROC})
- Statistics associated with matching/sensitive dimensionless parameters such as voltage or current gains, component ratios, pole Q, ... (almost always closely placed) dominated by $x_{\rm RLGRAD}$ and $x_{\rm RLVAR}$ (because locally $x_{\rm RPROC}$, $x_{\rm RWAFER}$, $x_{\rm RDIE}$ are all correlated and equal)
- Gradients are dominantly linear if spacing is not too large
- Special layout techniques using common centroid approaches can be used to eliminate (or dramatically reduce) linear gradient effects so, if employed, matching/sensitive parameters dominated by x_{RLVAR} but occasionally common centroid layouts become impractical or areas become too large so that gradients become nonlinear and in these cases gradient effects will still limit performance
- Higher-order gradient effects can be eliminated with layout approaches that cancel higher "moments" but area and effort may not be attractive



Determine the standard deviation of the pole frequency (or band edge) of the first-order passive filter.

Assume the process variables are zero mean with standard deviations given by

$$\sigma_{\frac{R_{PROC}}{R_{NOM}}} = 0.2$$
 $\sigma_{\frac{C_{PROC}}{C_{NOM}}} = 0.1$



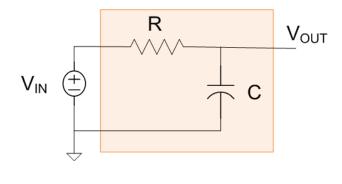
Since R and C are random variables, the pole p is also a random variable

Theorem: The sum of uncorrelated Gaussian random variables is a multivariate Gaussian random variable

Theorem: If $X_1 \dots X_m$ are uncorrelated random variables with standard deviations $\sigma_1, \sigma_2, \dots \sigma_m$, and $a_1, a_2, \dots a_m$ are constants, then the standard

deviation of the random variable $y = \sum_{i=1}^{m} a_i X_i$ is given by the expression

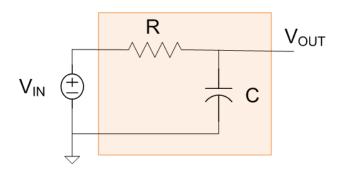
$$\sigma_{y} = \sqrt{\sum_{i=1}^{m} a_{i}^{2} \sigma_{i}^{2}}$$



$$p = \frac{1}{RC}$$

$$\sigma_{\underline{p}_{\text{NOM}}} \cong \sqrt{0.2^2 + 0.1^2} = 0.22$$

- 1. Determine the 3σ range in the pole location
- 2. Determine the percent of the process lots that will have a pole with mean that is within 10% of the nominal value
- 3. What can the designer do to tighten the band edge of this filter?



$$p = \frac{1}{RC}$$

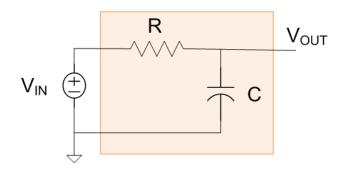
$$\sigma_{\underline{p}} \cong \sqrt{0.2^2 + 0.1^2} = 0.22$$

1. Determine the 3σ range in the pole location

The 3σ range is simply

$$0.34 \le \frac{p}{p_{NOM}} \le 1.66$$

So, if the nominal pole location is 10KHz, the average value of the pole location from lot to lot will vary between 3.4KHz and 16.6KHz



$$p = \frac{1}{RC}$$

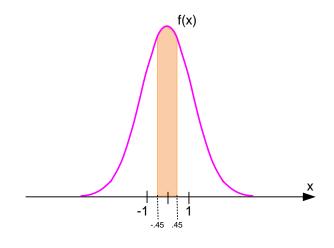
$$\sigma_{p \over p_{NOM}} \cong \sqrt{0.2^2 + 0.1^2} = 0.22$$

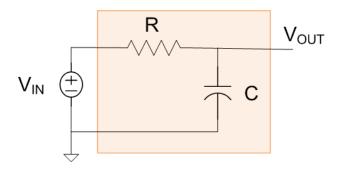
2. Determine the percent of the process lots that will have a pole with mean that is within 10% of the nominal value

$$\theta_{\text{prob}} = 2F_{N(0,1)}(0.45) - 1$$

$$\theta_{\text{prob}} = 2 \bullet .6736 - 1 = 0.347$$

Thus, approximately 35% of the wafer lots will have a pole within 10% of the nominal value





$$p = \frac{1}{RC}$$

$$\sigma_{p \over p_{NOM}} \cong \sqrt{0.2^2 + 0.1^2} = 0.22$$

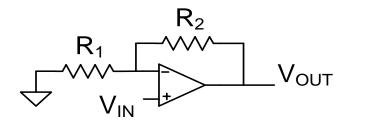
3. What can the designer do to tighten the band edge of this filter?

Modeling process variations in semiconductor processes

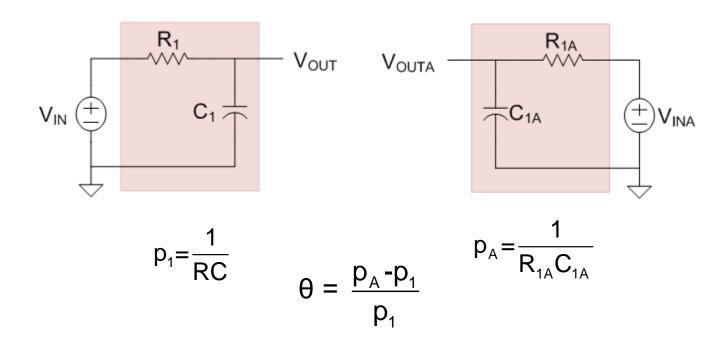


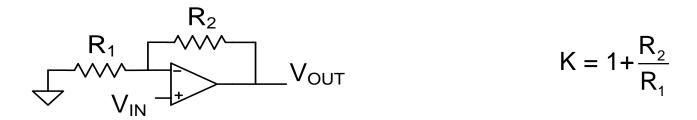
- Most characteristics of interest in a filter (and many other circuits) are highly nonlinear functions of multiple random variables
- Closed-form analytical expressions for pdf is often extremely difficult to obtain
- For most practical circuits, random component is small compared to the nominal component
- Linearization of characteristics of interest for purpose of statistical analysis is usually quite accurate and drastically simplifies analysis
- Monte Carlo analysis is widely used for statistical characterization but is often very time consuming and gives little insight into design optimization

Statistical Modeling of Dimensionless Parameters



$$K = 1 + \frac{R_2}{R_1}$$





Determine the standard deviation of the voltage gain K

Determine the yield if the nominal gain is 10 $\pm 1\%$

Assume a common centroid layout of R_1 and R_2 has been used and the area of R_1 is $100u^2$ and both resistors have the same resistance density and R_2 is comprised of K-1 copies of R_1 . Neglect variable edge effects in the layout

Assume also that:
$$A_{\rho}$$
=.01 μ m $\sigma_{R_{PROC} \over R_{NOM}} = 0.2$

 A_{ρ} is the Pelgrom matching parameter



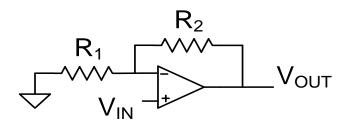
$$K = 1 + \frac{R_{2N} + R_{2R}}{R_{1N} + R_{1R}}$$

$$K = 1 + \frac{R_{2N} \left(1 + \frac{R_{2R}}{R_{2N}}\right)}{R_{1N} \left(1 + \frac{R_{1R}}{R}\right)}$$

$$K \cong 1 + \frac{R_{2N}}{R_{1N}} \left(1 + \frac{R_{2R}}{R_{2N}}\right) \left(1 - \frac{R_{1R}}{R_{1N}}\right)$$

$$K \cong 1 + \frac{R_{2N}}{R_{1N}} \left(1 + \frac{R_{2R}}{R_{2N}} - \frac{R_{1R}}{R_{1N}} \right)$$

$$K \cong \left(1 + \frac{R_{2N}}{R_{1N}}\right) + \frac{R_{2N}}{R_{1N}}\left(\frac{R_{2R}}{R_{2N}} - \frac{R_{1R}}{R_{1N}}\right)$$



$$K = 1 + \frac{R_2}{R_1}$$

Determine the standard deviation of the voltage gain K

$$K \cong \left(1 + \frac{R_{2N}}{R_{1N}}\right) + \frac{R_{2N}}{R_{1N}}\left(\frac{R_{2R}}{R_{2N}} - \frac{R_{1R}}{R_{1N}}\right)$$

$$K \cong K_N + (K_N - 1) \left(\frac{R_{2R}}{R_{2N}} - \frac{R_{1R}}{R_{1N}} \right)$$

$$R_{2R} \cong R_{2RPROC} + R_{2RGRAD} + R_{2RLVAR}$$

$$R_{1R} \cong R_{1RPROC} + R_{1RGRAD} + R_{1RLVAR}$$

But R_{2RPROC} and R_{1RPROC} are correlated

$$R_{2RPROC} = (K_N - 1)R_{1RPROC}$$

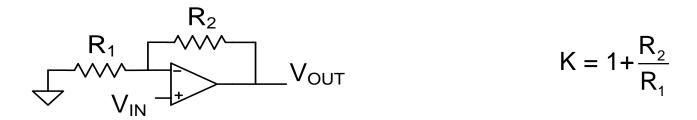
And, since a common centroid layout is used,

R_{2RGRAD} and R_{1RGRAD} are correlated

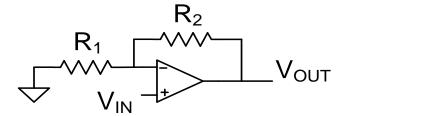
$$R_{2RGRAD} = (K_N - 1)R_{1RGRAD}$$

R_{2RLVAR} and R_{1RLVAR} are uncorrelated

$$\mathsf{K} \cong \mathsf{K}_{\mathsf{N}} + (\mathsf{K}_{\mathsf{N}} - 1) \left(\frac{R_{2RPROC} + R_{2RGRAD} + R_{2RLVAR}}{\mathsf{R}_{2\mathsf{N}}} - \frac{R_{1RPROC} + R_{1RGRAD} + R_{1RLVAR}}{\mathsf{R}_{1\mathsf{N}}} \right)$$



$$\begin{split} \mathsf{K} &\cong \mathsf{K_N} + \big(\mathsf{K_N} - 1\big) \Big(\frac{R_{2RPROC} + R_{2RGRAD} + R_{2RLVAR}}{R_{2N}} - \frac{R_{2RPROC} + R_{2RGRAD} + R_{2RLVAR}}{R_{1N}} \Big) \\ \mathsf{K} &\cong \mathsf{K_N} + \big(\mathsf{K_N} - 1\big) \Big(\frac{(K_N - 1)R_{1RPROC} + (K_N - 1)R_{1RGRAD} + R_{2RLVAR}}{R_{2N}} - \frac{R_{1RPROC} + R_{1RGRAD} + R_{1RLVAR}}{R_{1N}} \Big) \\ \mathsf{Since} \ \mathsf{R_{2N}} = (\mathsf{K_N} - 1)\mathsf{R_{1N}} \\ \mathsf{K} &\cong \mathsf{K_N} + \big(\mathsf{K_N} - 1\big) \Big(\frac{(K_N - 1)R_{1RPROC} + (K_N - 1)R_{1RGRAD}}{(\mathsf{K_N} - 1)R_{1N}} + \frac{R_{2RLVAR}}{R_{2N}} - \frac{R_{1RPROC} + R_{1RGRAD} + R_{1RLVAR}}{R_{1N}} \Big) \\ \mathsf{K} &\cong \mathsf{K_N} + \big(\mathsf{K_N} - 1\big) \Big(\Big[\frac{(K_N - 1)R_{1RPROC} + (K_N - 1)R_{1RGRAD}}{(\mathsf{K_N} - 1)R_{1N}} - \frac{R_{1RPROC} + R_{1RGRAD}}{R_{1N}} \Big] + \frac{R_{2RLVAR}}{R_{2N}} - \frac{R_{1RLVAR}}{R_{1N}} \Big) \\ \mathsf{K} &\cong \mathsf{K_N} + \big(\mathsf{K_N} - 1\big) \Big(\frac{(R_{2RLVAR} - R_{1RLVAR})}{(\mathsf{K_N} - 1)R_{1N}} - \frac{R_{1RLVAR}}{R_{2N}} - \frac{R_{1RLVAR}}{R_{2N}} \Big) \\ \mathsf{K} &\cong \mathsf{K_N} + \big(\mathsf{K_N} - 1\big) \Big(\frac{R_{2RLVAR}}{R_{2N}} - \frac{R_{1RLVAR}}{R_{2N}} - \frac{R_{1RLVAR}}{R_{2N}} \Big) \\ \mathsf{K} &\cong \mathsf{K}_{N} + \mathsf{K}_{N} + \mathsf{K}_{N} - \mathsf{K}_{N} + \mathsf{K}_{N} - \mathsf{K}_{N} + \mathsf{K}$$



$$K = 1 + \frac{R_2}{R_1}$$

$$K \cong K_N + (K_N - 1) \left(\frac{R_{2RLVAR}}{R_{2N}} - \frac{R_{1RLVAR}}{R_{1N}} \right)$$

Recall:
$$\sigma_{\underline{p}} \cong \sqrt{0.2^2 + 0.1^2} = 0.22$$
 (p was the pole of a dimensioned parameter)

$$\sigma_{\frac{\mathsf{K}}{\mathsf{K}_{\mathsf{N}}}} \cong \left(1 - \frac{1}{\mathsf{K}_{\mathsf{N}}}\right) \sqrt{\sigma_{\frac{R_{2R}}{\mathsf{R}_{2\mathsf{N}}}}^{2} + \sigma_{\frac{R_{1R}}{\mathsf{R}_{1\mathsf{N}}}}^{2}}$$

Statistical characterization of local random variations of resistors and capacitors

Theorem: If the perimeter variations and contact resistance are neglected, the standard deviation of the local random variations of a resistor of area A is given by the expression $\sigma_{\frac{R}{D}} = \frac{A_{\rho}}{\sqrt{A}}$

 A_{o} is a constant (has dimensions of μ m) and is not related to area!

Theorem: If the perimeter variations are neglected, the standard deviation of the local random variations of a capacitor of area A is given by the expression

$$\sigma_{\frac{C}{C_N}} = \frac{A_C}{\sqrt{A}}$$

 A_C is a constant (has dimensions of μ m) and is not related to area!

Note both of these expressions are independent of the value of R and C

Statistical characterization of local random variations of MOS transistor parameters

Theorem: If the perimeter variations are neglected, the variance of the local random variations of the normalized threshold voltage of a rectangular MOS transistor of dimensions W and L is given by the expression

$$\sigma_{\frac{V_T}{V_{T_N}}}^2 = \frac{A_{VTO}^2}{V_{T_N}^2 WL} \qquad \text{or as} \qquad \sigma_{\frac{V_T}{V_{T_N}}}^2 = \frac{A_{VT}^2}{WL}$$

Theorem: If the perimeter variations are neglected, the variance of the local random variations of the normalized C_{OX} of a rectangular MOS transistor of dimensions W and L is given by the expression

$$\sigma_{\frac{C_{OX}}{C_{OXN}}}^2 = \frac{A_{COX}^2}{WL}$$

Theorem: If the perimeter variations are neglected, the variance of the local random variations of the normalized mobility of a rectangular MOS transistor of dimensions W and L is given by the expression

$$\sigma_{\frac{\mu_R}{\mu_N}}^2 = \frac{A_{\mu}^2}{WL}$$

where the parameters A_X are all constants characteristic of the process (i.e. model parameters)

Statistical characterization of local random variations of MOS transistor parameters

$$\sigma_{\frac{R}{R_N}} = \frac{A_{\rho}}{\sqrt{A}} \qquad \sigma_{\frac{C}{C_N}} = \frac{A_{C}}{\sqrt{A}}$$

$$\sigma_{\frac{C}{C_N}}^2 = \frac{A_{C}^2}{\sqrt{A}}$$

$$\sigma_{\frac{C_{OX}}{C_{OXN}}}^2 = \frac{A_{COX}^2}{WL} \qquad \sigma_{\frac{\mu_R}{\mu_N}}^2 = \frac{A_{\mu}^2}{WL} \qquad \sigma_{\frac{V_T}{V_{T_N}}}^2 = \frac{A_{VTO}^2}{V_{T_N}^2 WL}$$

• The parameters A_p , A_C , A_μ , A_{COX} , and A_{VT0} are often termed "Pelgrom" parameters and are part of the PDK of a process

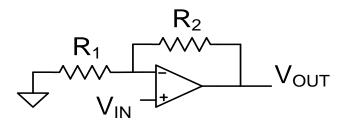
Matching properties of MOS transistors

MJM Pelgrom, ACJ Duinmaijer... - IEEE Journal of solid ..., 1989 - ieeexplore.ieee.org
The **matching properties** of the threshold voltage, substrate factor, and current factor of **MOS** transistors have been analyzed and measured. Improvements to the existing theory are given, as well as extensions for long-distance **matching** and rotation of devices. **Matching** ...

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Sept 2020

- The effects of edge roughness on the variance of resistors, capacitors, and transistors can readily be included but for most layouts is dominated by the area dependent variations
- There is some correlation between the model parameters of MOS transistors but they are often ignored to simplify calculations



$$K = 1 + \frac{R_2}{R_1}$$

$$K \cong K_{N} + (K_{N} - 1) \left(\frac{R_{2RLVAR}}{R_{2N}} - \frac{R_{1RLVAR}}{R_{1N}} \right)$$

$$\sigma_{K} \cong (K_{N} - 1) \sqrt{\sigma_{\frac{R_{2R}}{R_{2N}}}^{2} + \sigma_{\frac{R_{1R}}{R_{1N}}}^{2}}$$

$$\sigma_{K} \cong (K_{N} - 1) A_{\rho} \sqrt{\frac{1}{A_{R2}} + \frac{1}{A_{R1}}}$$

$$\sigma_{K} \cong (K_{N} - 1) A_{\rho} \sqrt{\frac{1}{(K_{N} - 1) A_{R1}} + \frac{1}{A_{R1}}}$$

$$R_{1}$$

$$V_{OUT}$$

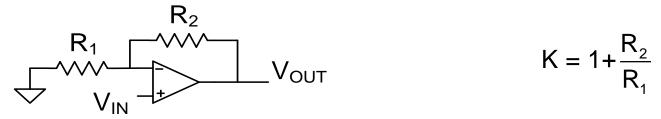
$$K = 1 + \frac{R_{2}}{R_{1}}$$

$$\sigma_{K} \cong (K_{N}-1)A_{\rho}\sqrt{\frac{1}{(K_{N}-1)A_{R1}}} + \frac{1}{A_{R1}}$$

$$\sigma_{K} \cong (K_{N}-1)\frac{A_{\rho}}{\sqrt{A_{R1}}}\sqrt{\frac{1}{(K_{N}-1)}} + 1 = \frac{A_{\rho}}{\sqrt{A_{R1}}}(K_{N}-1)\sqrt{\frac{K_{N}}{(K_{N}-1)}}$$

$$\sigma_{K} \cong \frac{A_{\rho}}{\sqrt{A_{R1}}}\sqrt{K_{N}(K_{N}-1)}$$

$$\sigma_{K} \cong \frac{A_{\rho}}{\sqrt{A_{R1}}}\sqrt{1 - \frac{1}{K_{N}}}$$

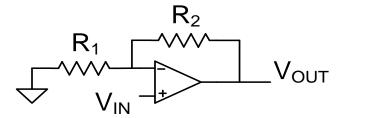


$$\sigma_{K} \cong \frac{A_{\rho}}{\sqrt{A_{R1}}} \sqrt{K_{N}(K_{N}-1)} \qquad A_{\rho}=.01u \qquad A_{R1}=100u^{2} \qquad \sigma_{\frac{R_{PROC}}{R_{NOM}}}=0.2$$

$$\sigma_{K} \cong \frac{.01}{10} \sqrt{K_{N}(K_{N}-1)} = .001 \sqrt{K_{N}(K_{N}-1)}$$

$$\sigma_{\frac{K}{K_{N}}} \cong .001 \sqrt{1-\frac{1}{K_{N}}}$$

- The standard deviation can be improved by increasing area but a 4X increase in area is needed for a 2X reduction in sigma
- Note the standard deviation of the normalized gain is much smaller than the standard deviation of the process variations



$$K = 1 + \frac{R_2}{R_1}$$

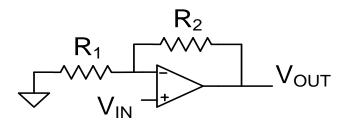
Determine the standard deviation of the voltage gain K

$$\sigma_{\frac{K}{K_N}} \cong .001 \sqrt{1 - \frac{1}{K_N}}$$

Determine the yield if the nominal gain is 10 $\pm 1\%$

$$\sigma_{\frac{K}{K_N}} \cong .001\sqrt{1-\frac{1}{10}} = .00095$$

$$\frac{K}{K_N} \cong N(1, 0.00095)$$



$$K = 1 + \frac{R_2}{R_1}$$

Determine the yield if the nominal gain is 10 $\pm 1\%$

$$\frac{\mathsf{K}}{\mathsf{K}_{\mathsf{N}}} \;\cong\; \mathsf{N}\big(\mathsf{1,}\;\; 0.00095\big)$$

$$.99 < \frac{K}{K_N} < 1.01$$

$$-.01 < \frac{K}{K_N} -1 < .01$$

$$\frac{\frac{K}{K_N} - 1}{0.00095} \cong N(0,1)$$

$$-10 < \frac{\frac{K}{K_N}}{.00095} < 10$$

These are 10 sigma values!

The gain yield is essentially 100%

Could substantially decrease area or increase gain accuracy if desired

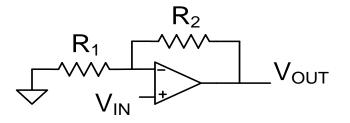


Determine the yield if the nominal gain is $10 \pm 1\%$

Assume a common centroid layout of R_1 and R_2 has been used and the area of R_1 is $10u^2$ and both resistors have the same resistance density and R_2 is comprised of K-1 copies of R_1 . Neglect variable edge effects in the layout

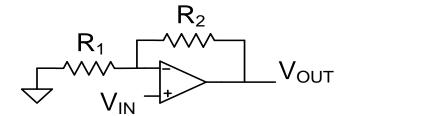
$$A_{\rho}$$
=.025 μ m
$$\sigma_{\frac{R_{PROC}}{R_{NOM}}} = 0.2$$

Note this is simply a 10X reduction in area from previous example and an increase in $A_{\rm p}$ by a factor of 2.5



$$K = 1 + \frac{R_2}{R_1}$$

$$\begin{split} \sigma_{\mathsf{K}} &\cong \frac{\mathsf{A}_{\rho}}{\sqrt{\mathsf{A}_{\mathsf{R}1}}} \sqrt{\mathsf{K}_{\mathsf{N}} (\mathsf{K}_{\mathsf{N}} - 1)} & \mathsf{A}_{\rho} \text{=}.025 \text{um } \mathsf{A}_{\mathsf{R}1} \text{=} 10 \text{um}^2 & \sigma_{\frac{R_{\mathit{PROC}}}{R_{\mathit{NOM}}}} = 0.2 \\ \sigma_{\mathsf{K}} &\cong \frac{.025}{\sqrt{10}} \sqrt{\mathsf{K}_{\mathsf{N}} (\mathsf{K}_{\mathsf{N}} - 1)} = .0079 \sqrt{\mathsf{K}_{\mathsf{N}} (\mathsf{K}_{\mathsf{N}} - 1)} \\ \sigma_{\frac{\mathsf{K}}{\mathsf{K}_{\mathsf{N}}}} &\cong .0079 \sqrt{1 - \frac{1}{\mathsf{K}_{\mathsf{N}}}} \end{split}$$



$$K = 1 + \frac{R_2}{R_1}$$

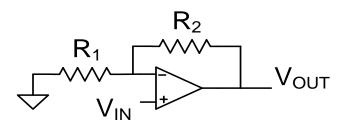
Determine the standard deviation of the voltage gain K

$$\sigma_{\frac{\mathsf{K}}{\mathsf{K}_{\mathsf{N}}}} \cong .0079 \sqrt{1 - \frac{1}{\mathsf{K}_{\mathsf{N}}}}$$

Determine the yield if the nominal gain is $10\pm1\%$

$$\sigma_{\frac{K}{K_N}} \cong .0079 \sqrt{1 - \frac{1}{10}} = .0075$$

$$\frac{K}{K_N} \cong N(1, 0.0075)$$



$$K = 1 + \frac{R_2}{R_1}$$

Determine the yield if the nominal gain is 10 $\pm 1\%$

$$\frac{K}{K_N} \cong N(1, 0.0075)$$

$$.99 < \frac{K}{K_N} < 1.01$$

$$-.01 < \frac{K}{K_N} -1 < .01$$

$$\frac{\frac{K}{K_N} - 1}{0.0075} \cong N(0,1)$$

$$-1.33 < \frac{\frac{K}{K_N}}{.0075} < 1.33$$

Have dropped from 10 sigma to 1.33 sigma boundaries

$$Y = 2F_{N(0,1)}(1.33)-1 = 2*.9082-1 = 0.8164$$

Dramatic drop from 100% yield to about 82% yield!

Statistical Modeling of Filter Characteristics

The variance of dimensioned filter parameters (e.g. ω_0 , poles, band edges, ...) is often very large due to the process-level random variables which dominate

The variance of dimensionless filter parameters (e.g. Q, gain, ...) are often quite small since in a good design they will depend dominantly on local random variations which are much smaller than process-level variations

The variance of dimensionless filter parameters is invariably proportional to the reciprocal of the square root of the relevant area and thus can be managed with appropriate area allocation

Linearization of Functions of a Random Variable

- Characteristics of most circuits of interest are themselves random variables
- Relationship between characteristics and the random variables often highly nonlinear
- Ad Hoc manipulations (repeated Taylor's series expansions) were used to linearize the characteristics in terms of the random variables

$$Y \cong Y_N + \sum_{i=1}^{n} (a_i x_{Ri})$$

• This is important because if the random variables are uncorrelated the variance of the characteristic can be readily obtained

$$\sigma_Y^2 \cong \sum_{i=1}^n \left(a_i^2 \sigma_{x_{Ri}}^2 \right)$$

$$\sigma_{\frac{Y}{Y_{i}}}^2 \cong \frac{1}{Y_N^2} \bullet \sum_{i=1}^n \left(a_i^2 \sigma_{x_{Ri}}^2 \right)$$

- This approach was applicable since the random variables are small
- These Ad Hoc manipulations can be formalized and this follows

Formalization of Statistical Analysis

Consider a function of interest Y

$$Y = f(x_{1N}, x_{2N}, ..., x_{nN}, : x_{1R}, x_{2R}, ..., x_{nR}) = f([X_N], [X_R])$$

This can be expressed in a multi-variate power series as

$$Y \cong f\left(\begin{bmatrix} X_N \end{bmatrix}, \begin{bmatrix} X_R \end{bmatrix}\right)\Big|_{[X_R]=[0]} + \sum_{i=1}^n \left(\frac{\partial f}{\partial x_i}\Big|_{[X_N],[X_R]=[0]} \bullet x_{Ri}\right) + \sum_{i=1}^n \left(\frac{\partial^2 f}{\partial x_j \partial x_i}\Big|_{[X_N],[X_R]=[0]} \bullet x_{Ri} x_{Rj}\right) + \dots$$

If the random variables are small compared to the nominal variables

$$Y \cong f\left(\left[X_{N}\right],\left[X_{R}\right]\right)\Big|_{\left[X_{R}\right]=\left[0\right]} + \sum_{i=1}^{n} \left(\frac{\partial f}{\partial x_{i}}\Big|_{\left[X_{N}\right],\left[X_{R}\right]=\left[0\right]} \bullet x_{Ri}\right)$$

If the random variable are uncorrelated, it follows that

$$\sigma_{Y}^{2} = \sum_{i=1}^{n} \left(\left[\frac{\partial f}{\partial x_{i}} \Big|_{[X_{N}],[X_{R}]=[0]} \right]^{2} \bullet \sigma_{x_{Ri}}^{2} \right)$$

$$\sigma_{\frac{Y}{Y_{N}}}^{2} = \frac{1}{Y_{N}^{2}} \sum_{i=1}^{n} \left(\left[\frac{\partial f}{\partial x_{i}} \Big|_{[X_{N}],[X_{R}]=[0]} \right]^{2} \bullet \sigma_{x_{Ri}}^{2} \right)$$

Formalization of Statistical Analysis

$$Y = f(x_{1N}, x_{2N}, ..., x_{nN}, : x_{1R}, x_{2R}, ..., x_{nR}) = f([X_N], [X_R])$$

$$\sigma_{\frac{Y}{Y_N}}^2 = \frac{1}{Y_N^2} \sum_{i=1}^n \left[\left[\frac{\partial f}{x_i} \Big|_{[X_N],[X_R]=[0]} \right]^2 \bullet \sigma_{x_{Ri}}^2 \right]$$

Recall:

$$\int_{x}^{f} = \frac{\partial f}{\partial x} \frac{x}{f}$$

$$S_{x}^{f} = \frac{\partial f}{\partial x} \frac{x}{f}$$

$$= \left(S_{x_{i}}^{f}\right)^{2} \Big|_{[X_{N}],[x_{R}]=0} = \left(S_{x_{i}}^{f}\right)^{2} \Big|_{[X_{N}],[x_{R}]=0} \bullet \frac{Y_{N}^{2}}{X_{N_{i}}^{2}}$$

Thus:

$$\sigma_{rac{Y}{Y_N}}^2 = \sum_{i=1}^n \left[\left[S_{x_i}^f \Big|_{[X_N]} \right]^2 ullet \sigma_{rac{X_{Ri}}{X_{Ni}}}^2
ight]$$

- Sensitivity analysis often used for statistical characterization of filter performance
- This is often much faster and less tedious than doing the linearization as described above though actually concepts are identical



Stay Safe and Stay Healthy!

End of Lecture 14